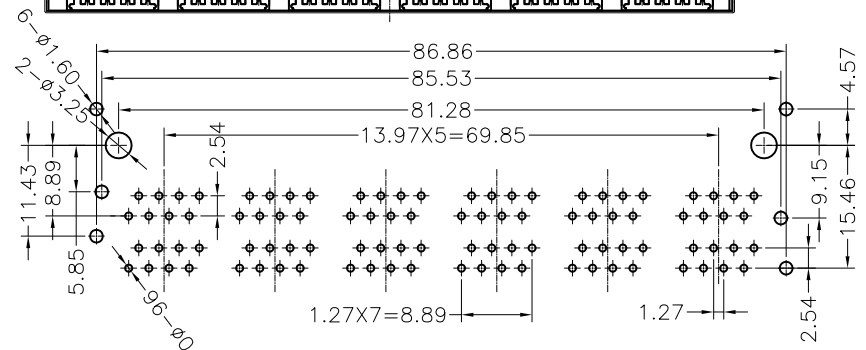
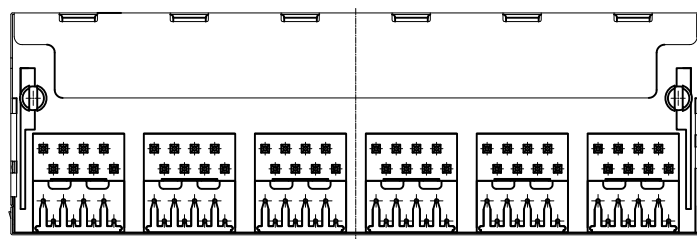


NOTES:
MATERIAL:
 1.HOUSING MATERIAL :GLASS FILLED POLYESTER(UL94V-0).
 2.CONTACT MATERIAL :PHOSPHOR BRONZE ϕ 0.46mm (C5100).
 3.PLATING :GOLD PLATING OVER NICKEL.
 4.SHIELD: COPPER ALLOY 0.20mm THICKNESS PLATING NI.
ELECTRICAL:
 1.VOLTAGE RATING :125 VAC RMS.
 2.CURRENT RATING :1.5 AMP.
 3.CONTACT RESISTANCE :50 MILLIOHMS MAX.
 4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC.
 5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.
MECHANICAL:
 1.DURRABILITY :750 CYCLES MIN.
 2.PCB RETENTION PRE-SOLDER :1 LB MIN.
ENVIRONMENTAL:
 1.STORAGE : -40°C TO +85°C.
 2. OPERATION : 0°C TO 70°C.
 MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68,SUBPART F.



PC Board Layout

| | | | | | |
|----|------------|---------------------------|---------------|-------------------|-----------------|
| 设计 | 赵佰友 | Coorle Technology | | | |
| 审核 | 赵来峰 | 文件号 FILE NO. | 图号 DWG NO. | | |
| 核准 | 李金强 | 名称 TITLE 59-2*6-8P8C-S | | | |
| 日期 | 2016-08-12 | 制图 DRAW Oscar | 角法 PROJ. | 图幅 SHEET 1 / 1 | 比例 SCALE 1:1 |
| | | | 图幅 SIZE A3 | 更改 REV A | |